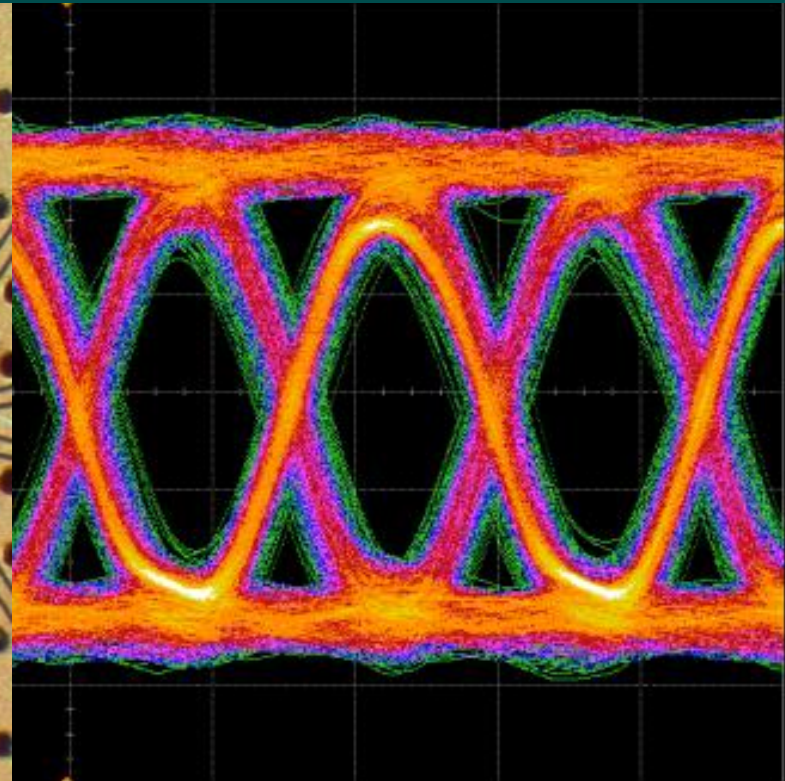
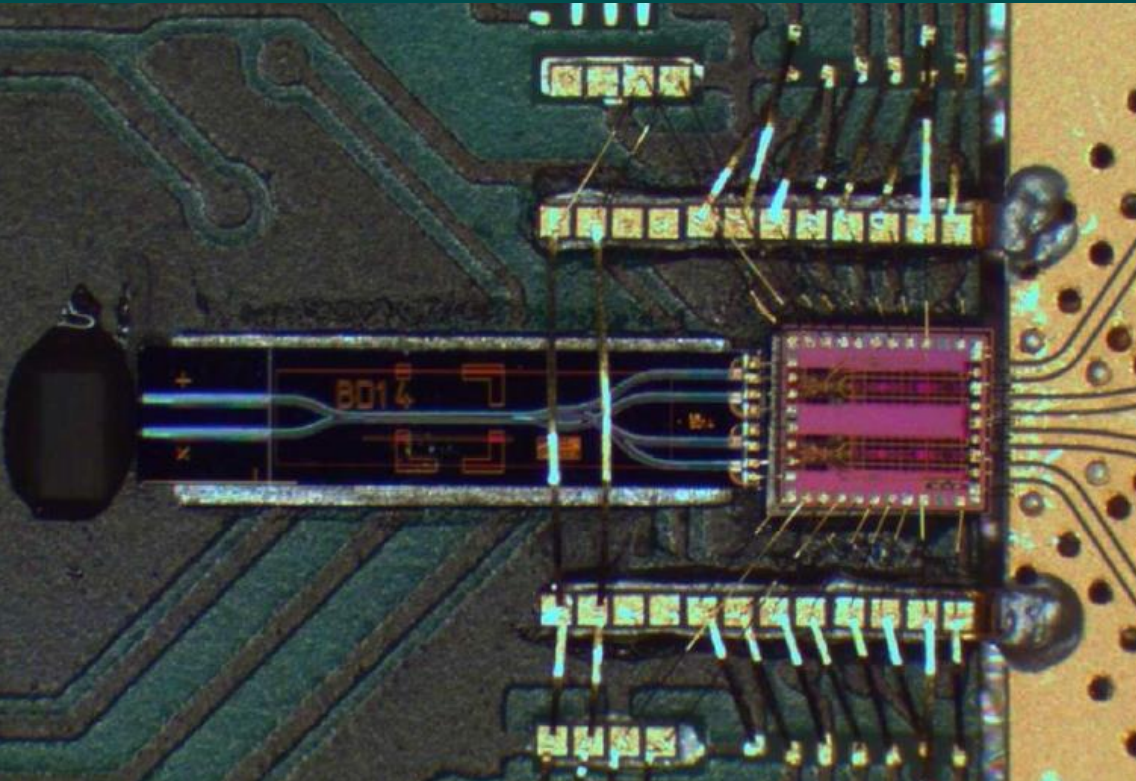


Broadband Circuits for Wireless and Wireline Communications



1. INTRODUCTION



- Learn about broadband communication systems with an emphasis on “wireline” communications (fiber optics)
- Learn how these systems operate, their performance specifications and hardware requirements
- This lecture will concentrate on the “frontend” electronics, driver and receiver amplifiers
- We will learn broadband circuits types on receivers and transmitters, how they are analyzed and how they are designed
- We will have “hands-on” exercises on designing broadband circuits

Method

- Lecturer: (https://www.ihe.kit.edu/mitarbeiter_ulusoy.php)
- Slides will be provided that will be annotated during the lecture, students will receive the slides with the notes
- It is recommended that you take your own additional notes
- In the Lab portion, the concepts thought in the lecture will be exercised in “hands-on” design tasks
- Final exam will be based on published literature and a 20 minute presentation, own simulations using the Lab material is encouraged and will be considered as a bonus

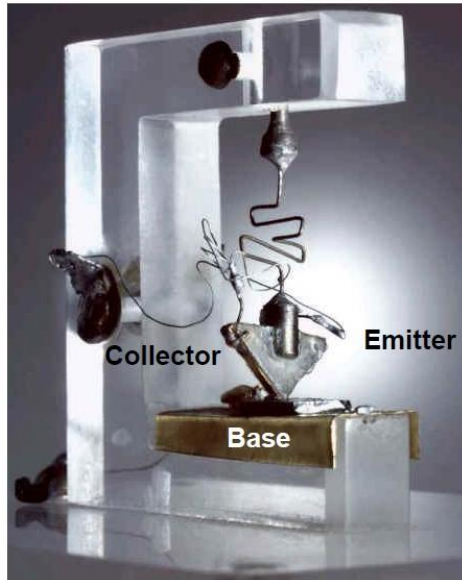
Additional References

- The slide set with notes from Ulusoy will be sufficient, additional recommended references:

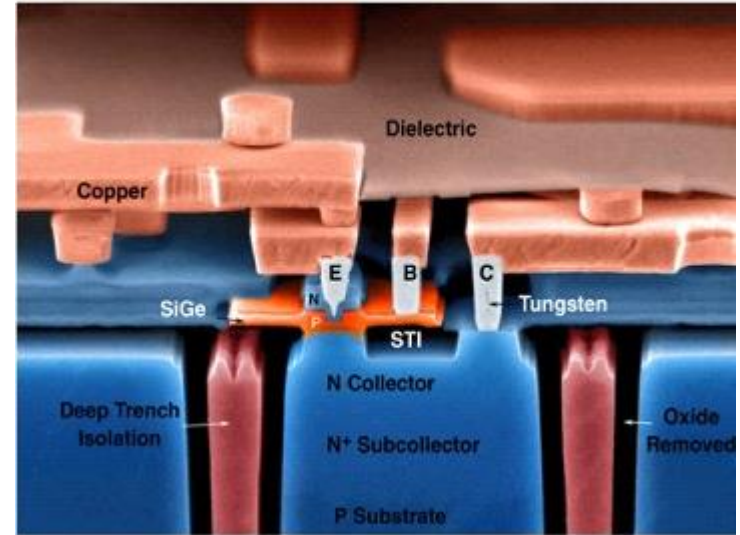
Eduard Säckinger, “Broadband Circuits for Optical Fiber Communications”
John Wiley & Sons, 2005

Behzad Razavi “Design of Integrated Circuits for Optical Communications”
Wiley, 2012

Broadband Communications



1947: First transistor
Operational in KHz range
60's: IC era starts (few transistors)

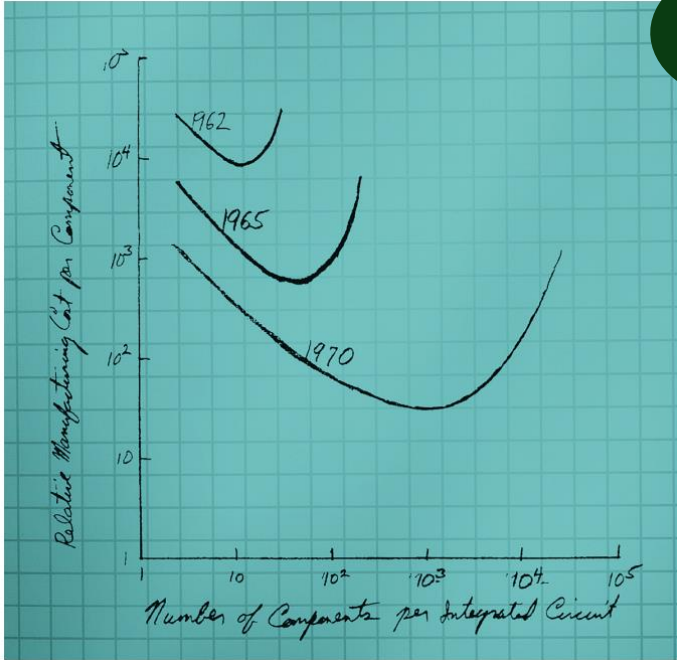


Cross-section of a SiGe HBT
Operational in THz range
ICs with billions of nanoscale transistors

Transistor is the most important invention of the 20th century!

Broadband Communications

- Like in every other electronics lecture: Moore's Law



Chris Mack "The multiple lives of Moore's Law"
IEEE Spectrum, vol. 52, issue 4

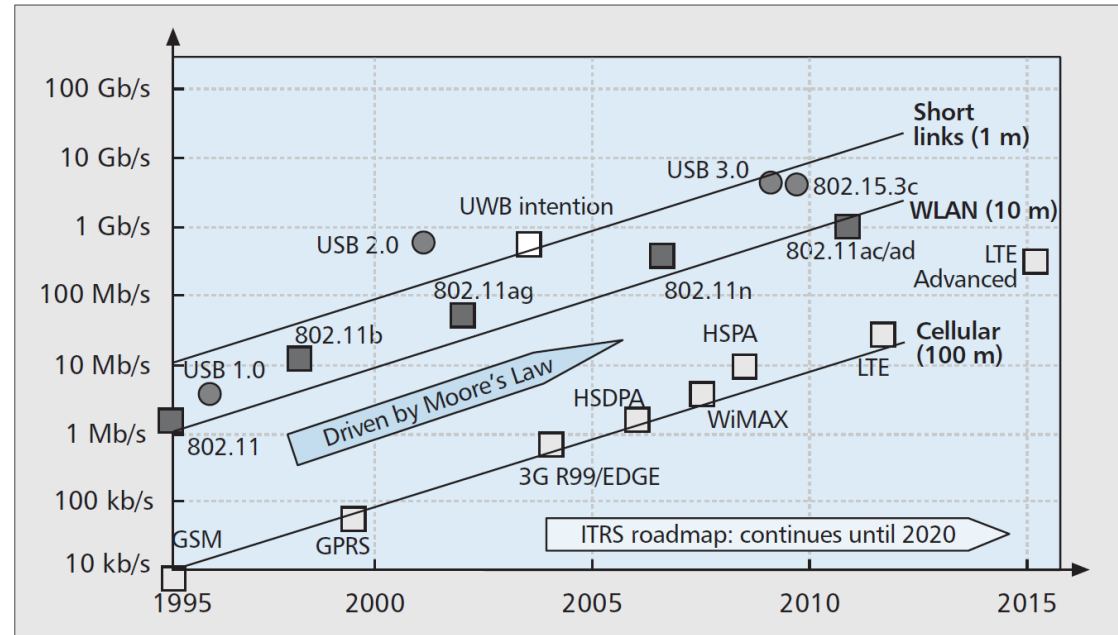


- Moore:** Relative manufacturing cost per component decreases for increasing number of components in an IC (1965)
- The # of transistors in an IC doubles every 1.5 years
- Self-fulfilling prophecy, ITRS (International Technology Roadmap for Semiconductors)

Broadband Communications

The incredible growth of semiconductor industry and digital electronics means also more data needs to move from point A to point B

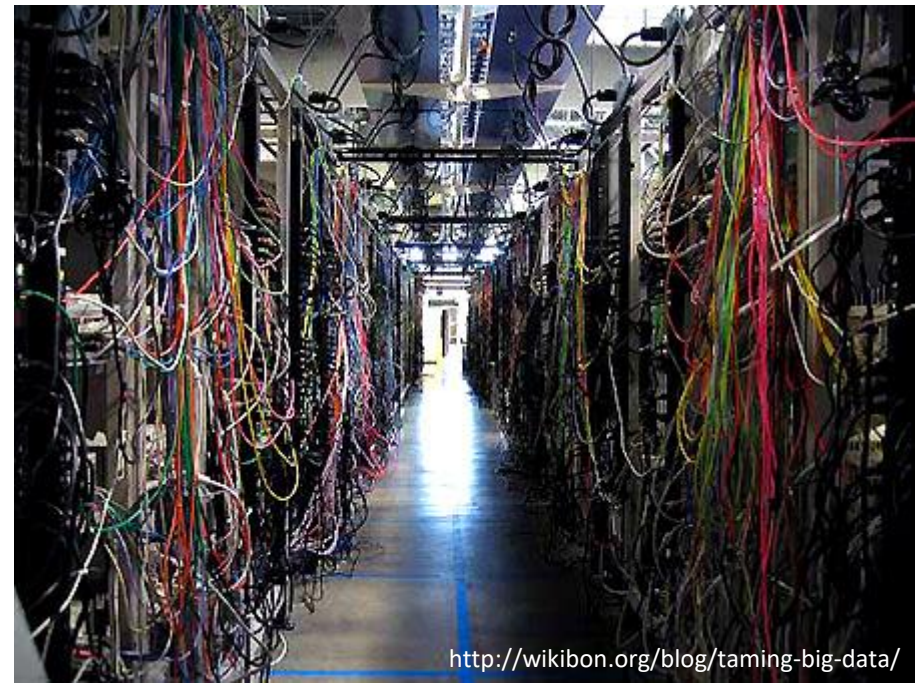
A. Fehske et. Al. "The Global Carbon Footprint of Mobile Communications – The Ecological and Economic Perspective"
IEEE Communications Magazine, Aug. 2011



Big Data is Coming ! Also internet of things, smart cities, body area networks, intelligent mobility, 5G & 6G....

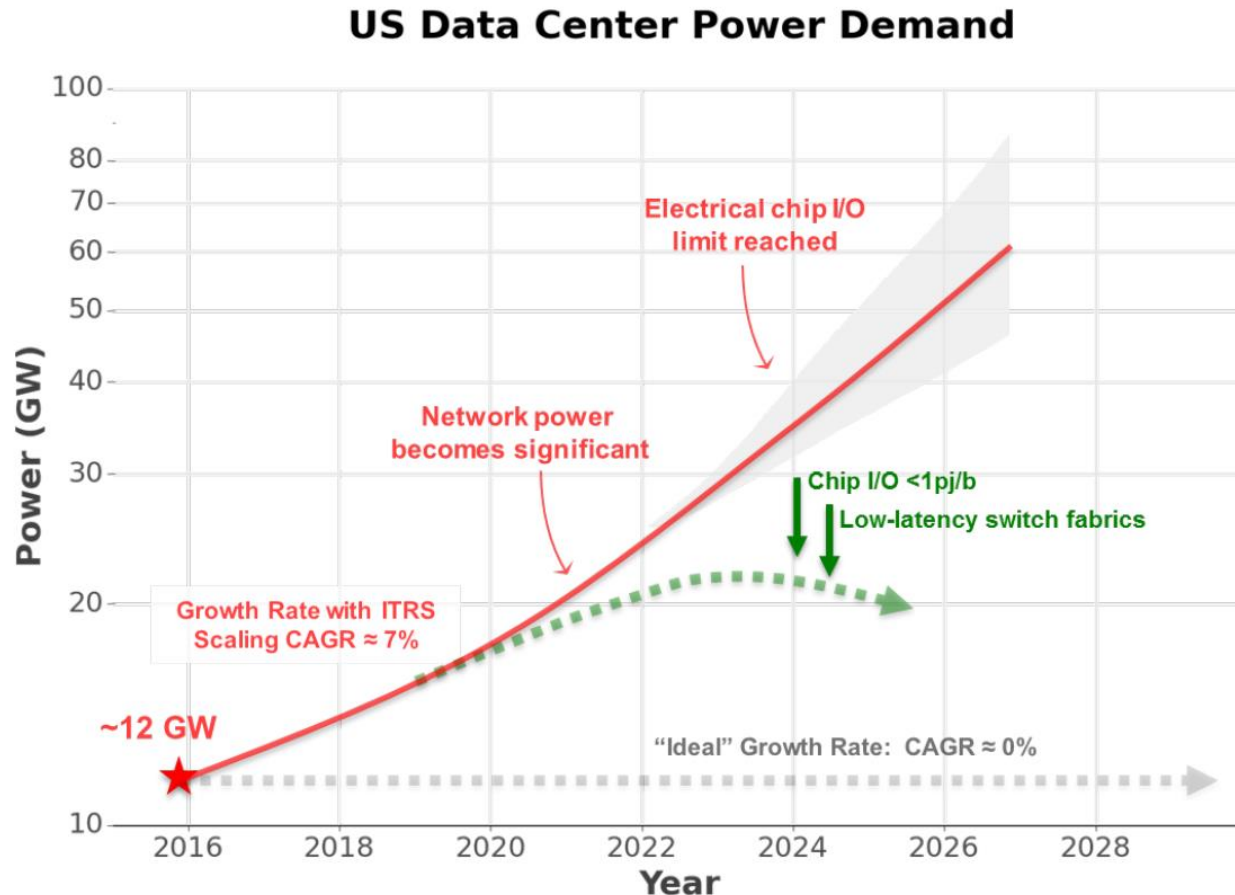
By 2022 global IP traffic will reach 396 exabytes per Month

It would take one person over 5 million years to watch the amount of video that will cross global IP networks each month in 2018



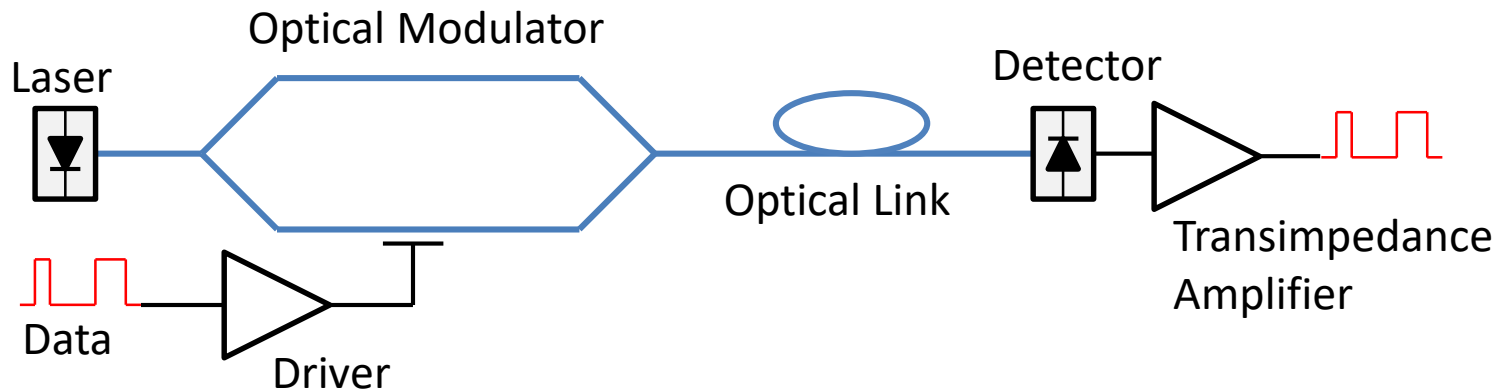
Broadband Communications

- The energy consumption in data centers alone is significant! Currently 2.5% of all energy in the US, expectation x2 in the next 8 years



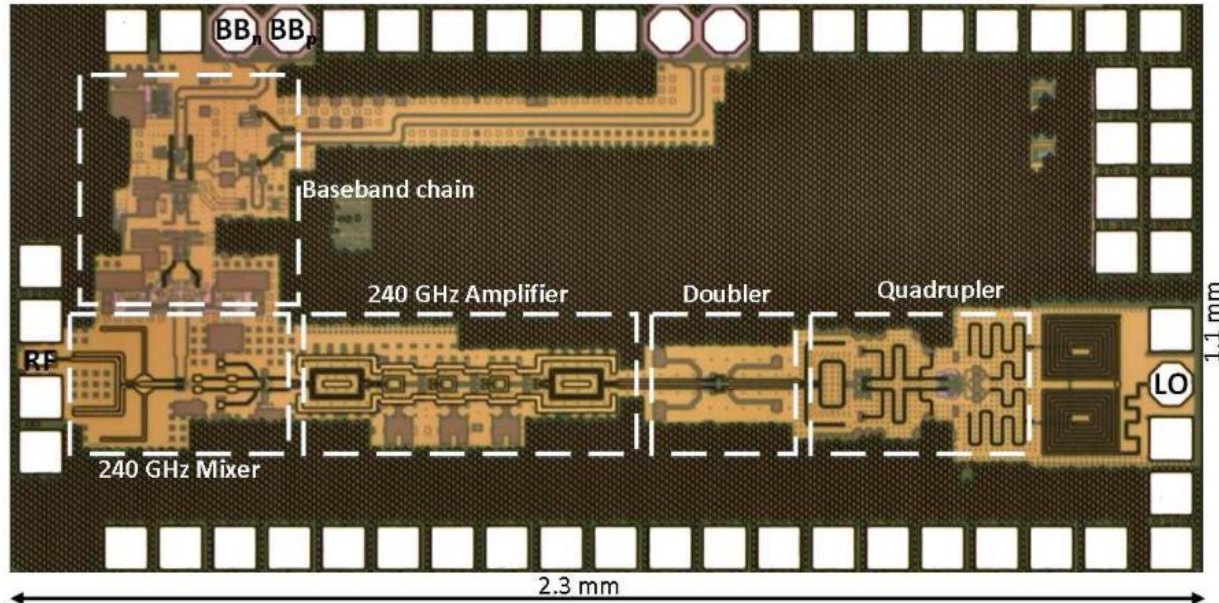
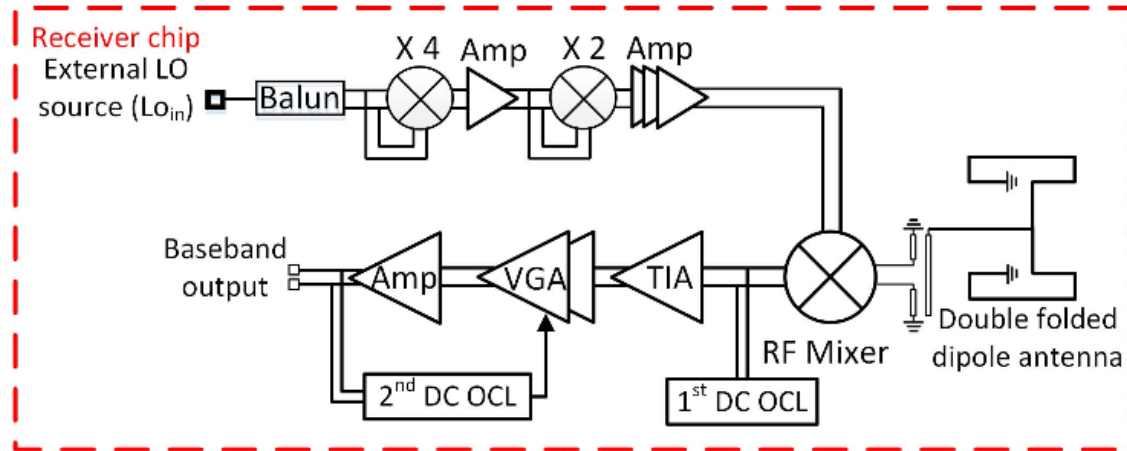
Broadband Circuits

- The receiver and transmitter electronics play a crucial role in the overall system budget of wireline communications
- This is an area of intensive research, the overall goal is to improve link efficiency expressed in pJ/bit
- In fiber optics, electronic/photonic interfaces are a typical bottleneck in terms of data rate per lane and power consumption



Broadband Circuits

- In wireless communications baseband electronics start to become more and more like a photonic frontend



M. H. Eissa *et al.*, "Wideband 240-GHz Transmitter and Receiver in BiCMOS Technology With 25-Gbit/s Data Rate," in *IEEE Journal of Solid-State Circuits*, vol. 53, no. 9, pp. 2532-2542, Sept. 2018.

Broadband Circuits: Challenges

- On the receiver side,
 - The noise generated at the receiver amplifier
input referred noise current, sensitivity
 - The receiver amplifier determines E/O bandwidth, hence the data rate per lane.
electro/optical bandwidth
 - The linear response of the receiver amplifier
inter-symbol interference, linear distortion
 - Non-linear response of the receiver amplifier
total harmonic distortion, dynamic range
 - Power consumption
efficiency

Broadband Circuits: Challenges

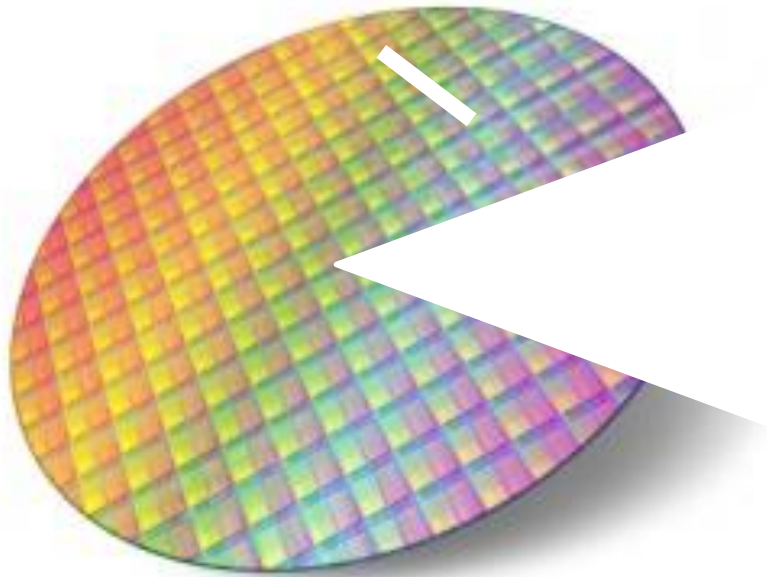
- On the transmitter side,
 - Capacitive load with high voltage (or current) swing
output voltage or current swing
 - The driver amplifier determines E/O bandwidth, hence the data rate per lane.
electro/optical bandwidth
 - Dynamic turn-on/turn-off behavior of the amplifier
extinction ratio
 - The linear response of the driver amplifier
inter-symbol interference, linear distortion
 - Non-linear response of the driver amplifier
total harmonic distortion
 - Power consumption & **efficiency**

Law of Semiconductors:

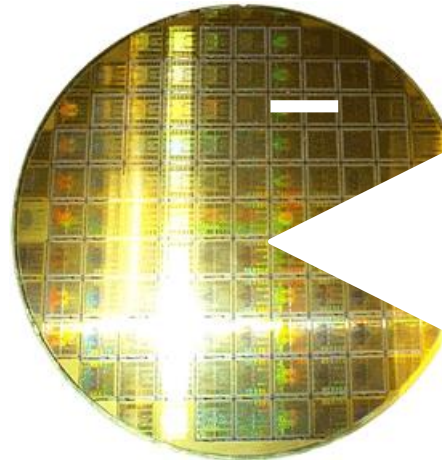
“What can be done in silicon, shall be done in silicon...
And, what can be done in CMOS shall be done in CMOS.”

Anonymous

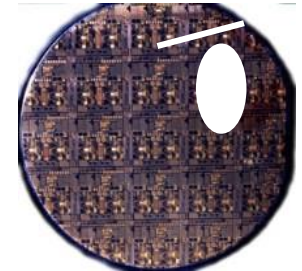
CMOS



SiGe



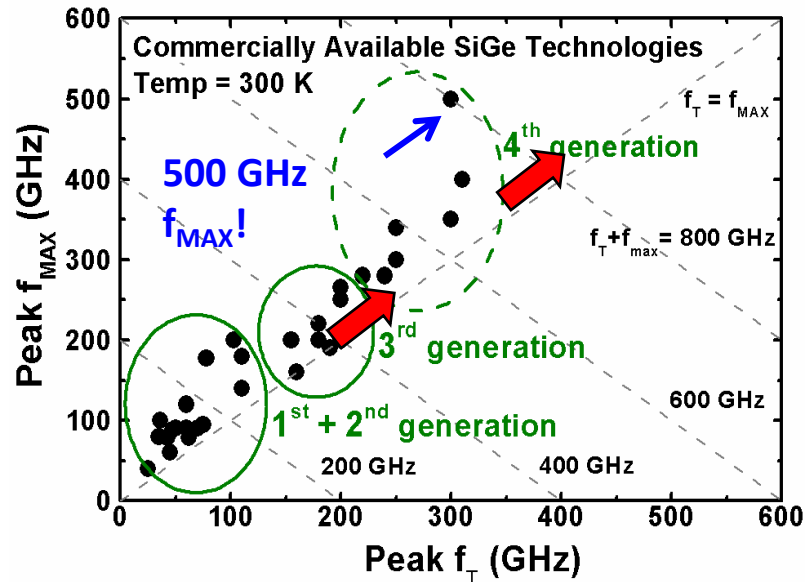
III-V



(if there is a business case)

IC Technologies

- Moore's Law is typically quoted for digital ICs (memories, CPUs...)
- However, similar trends observed for analog ICs, especially in terms of performance

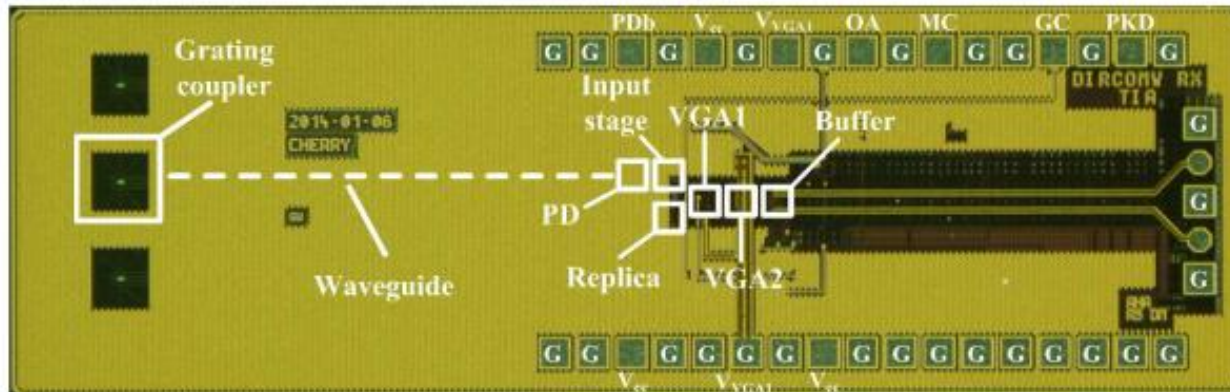
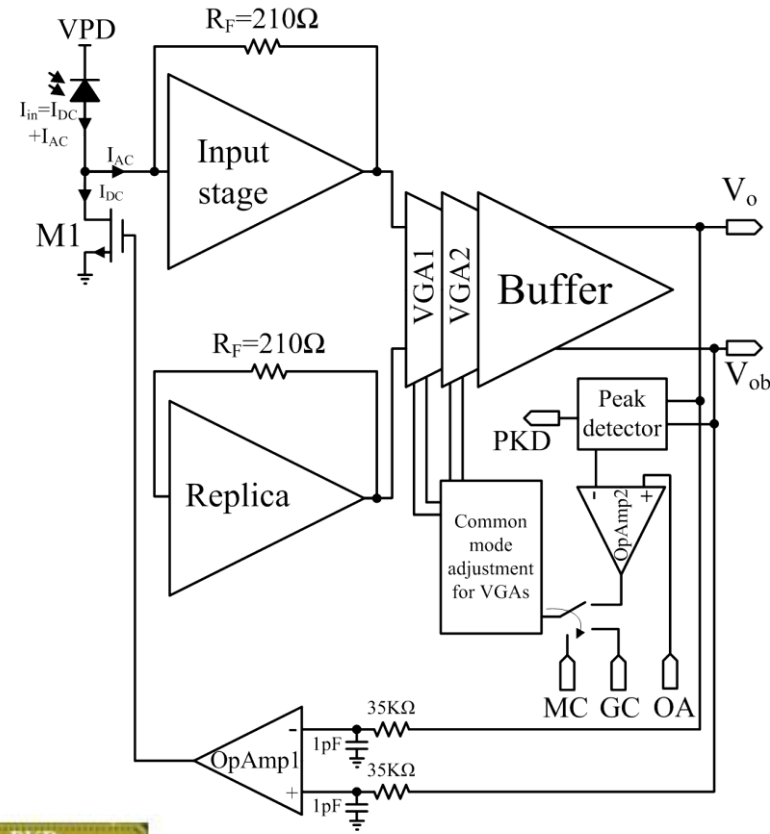


- # of transistors remain relatively fixed for analog ICs
 - Tremendous improvement in performance e.g. SiGe approximately x5 within 20 years
 - f_T : Transit frequency
Frequency current gain (**H21**) equals 1
 - f_{max} : Maximum frequency of oscillation
Frequency **maximum available gain** equals 1
- ...We will learn about these terms

- Understanding transistor limitations is absolutely essential to achieve desired broadband circuit performance
- Device capacitances, transconductance, breakdown mechanisms, non-linearity, dynamic behaviour etc.

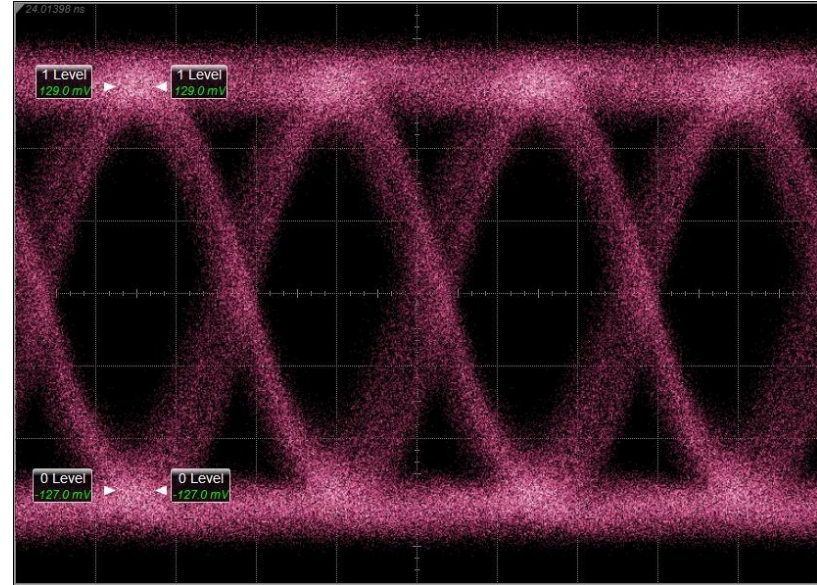
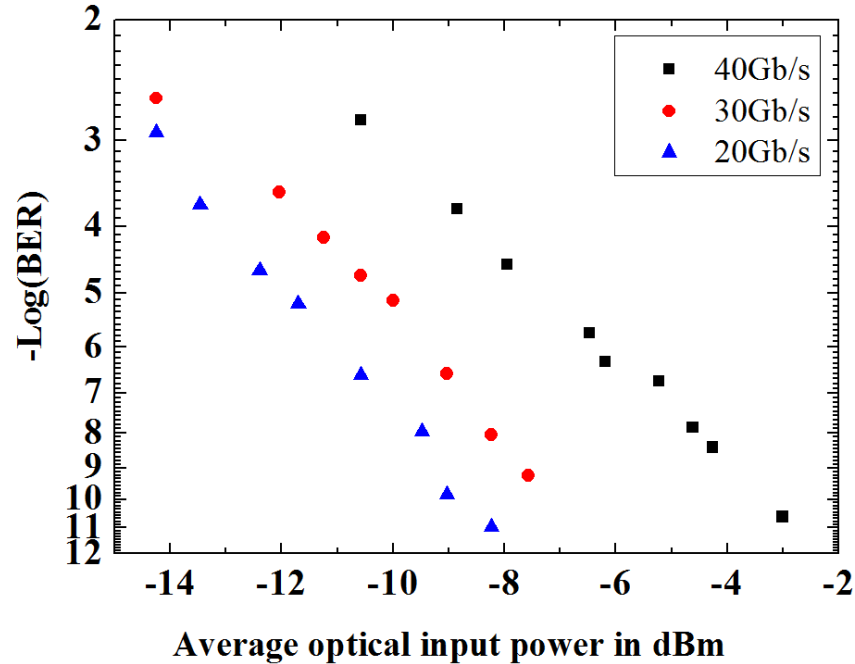
Current Research Examples

- Implemented in SiGe EPIC 0.25 μm technology
- Single-ended linear TIA with integrated Ge photo diodes constituting a direct detection receivers for OOK and PAM modulation techniques
- Two modes of operation: manual gain control and automatic gain control
- Input overload current compensation up to 4mA and DC offset cancellation circuitry
- The fastest integrated Si photonics receiver



Current Research Examples

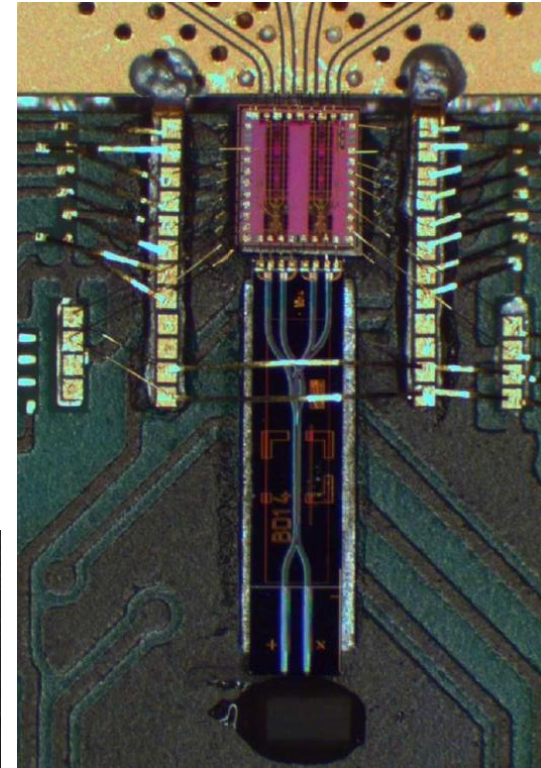
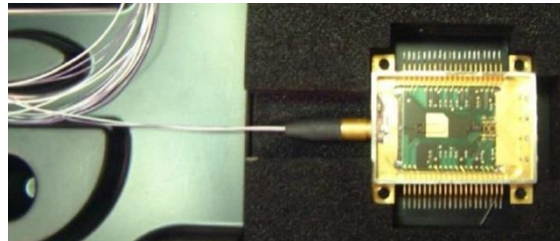
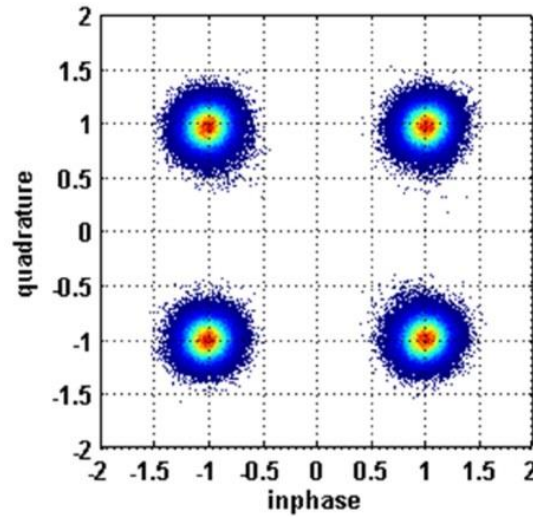
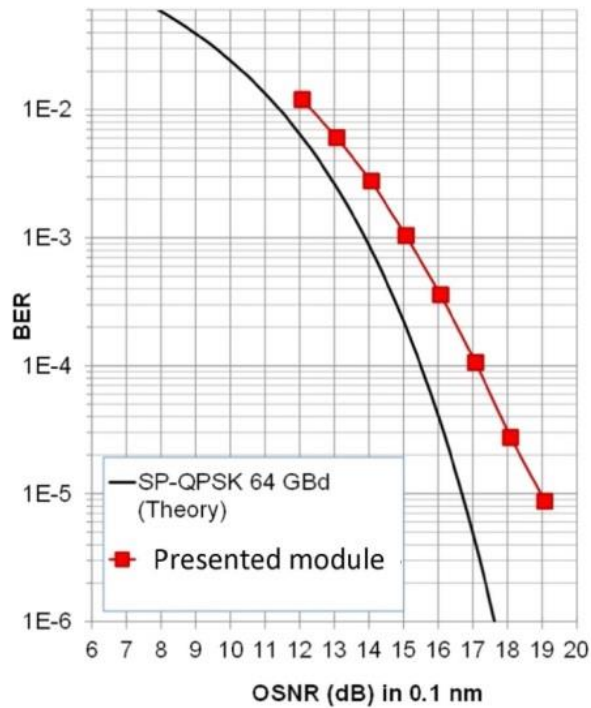
- Measurements



Eye diagram at a photo current of 300 μA at 40 Gb/s

A. Awny, R. Nagulapalli, G. Winzer, M. Kroh, D. Micusik, S. Lischke, D. Knoll, G. Fischer, D. Kissinger, A. C. Ulusoy, L. Zimmermann, L., "A 40 Gb/s Monolithically Integrated Linear Photonic Receiver in a BiCMOS SiGe:C Technology," in *Microwave and Wireless Components Letters, IEEE*, vol.25, no.7, pp.469-471, July 2015

Current Research Examples



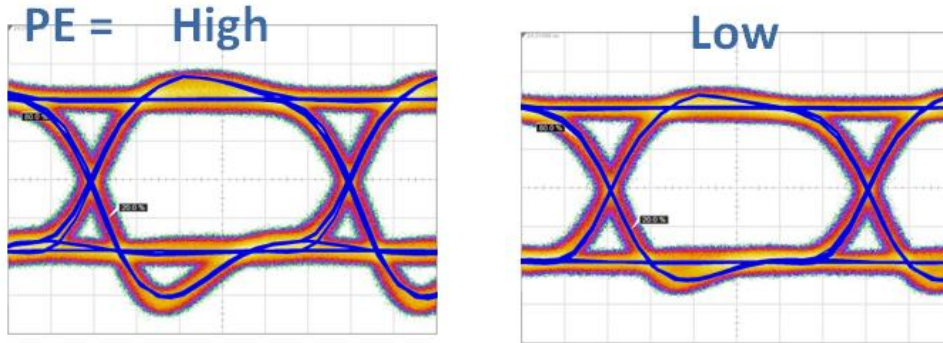
- The shown TIA integrated in a two channel electro/optical module
- Measured BER and constellation diagram at 128 Gbit/s data transmission
- State of the art electro/optical performance

A. Awny, A. C. Ulusoy et al., "23.5 A dual 64Gbaud 10k 5% THD linear differential transimpedance amplifier with automatic gain control in 0.13um BiCMOS technology for optical fiber coherent receivers," 2016 IEEE International Solid-State Circuits Conference (ISSCC), San Francisco, CA, 2016

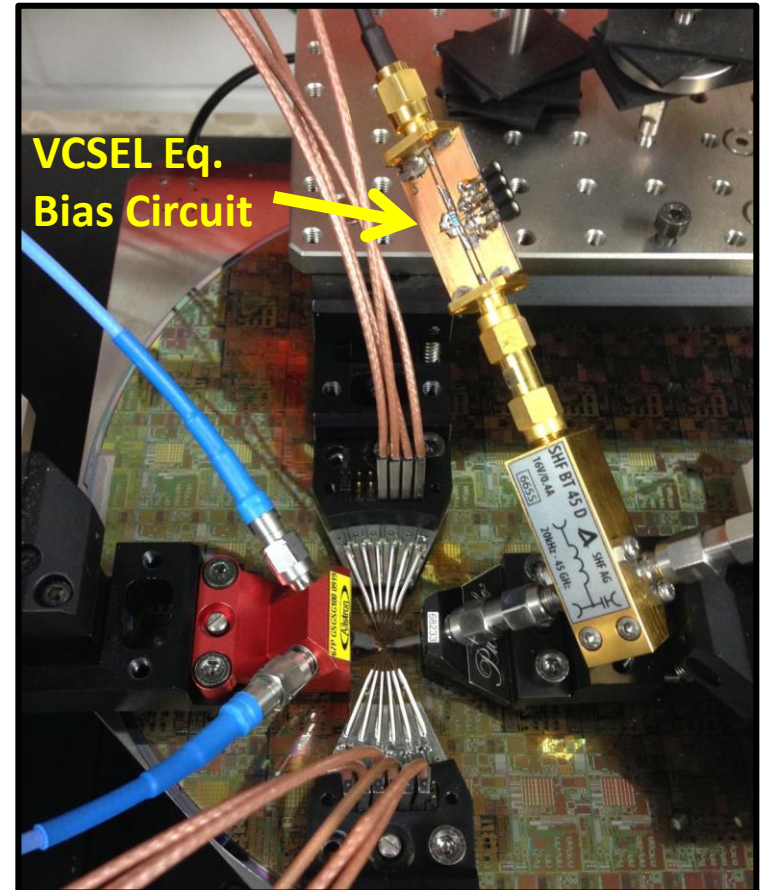
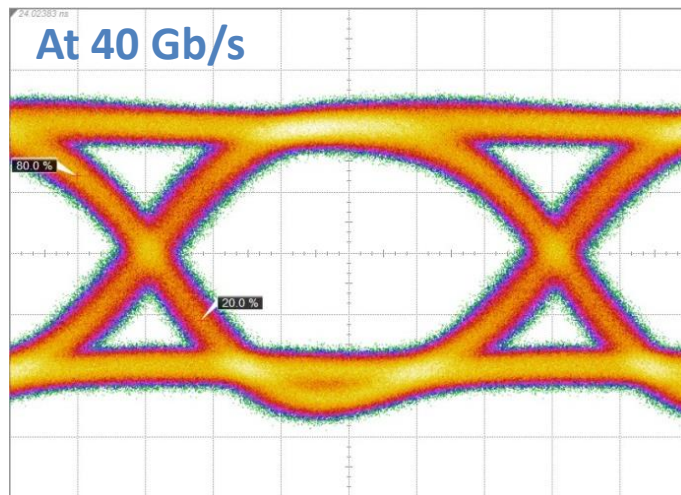
Current Research Examples

- **VCSEL Driver**

Conditions: 25 Gb/s, $I_{B/M} = 4/4$ mA ($V_{CC_0} = 3.7$ V, $V_{REF} = 130$ mV)

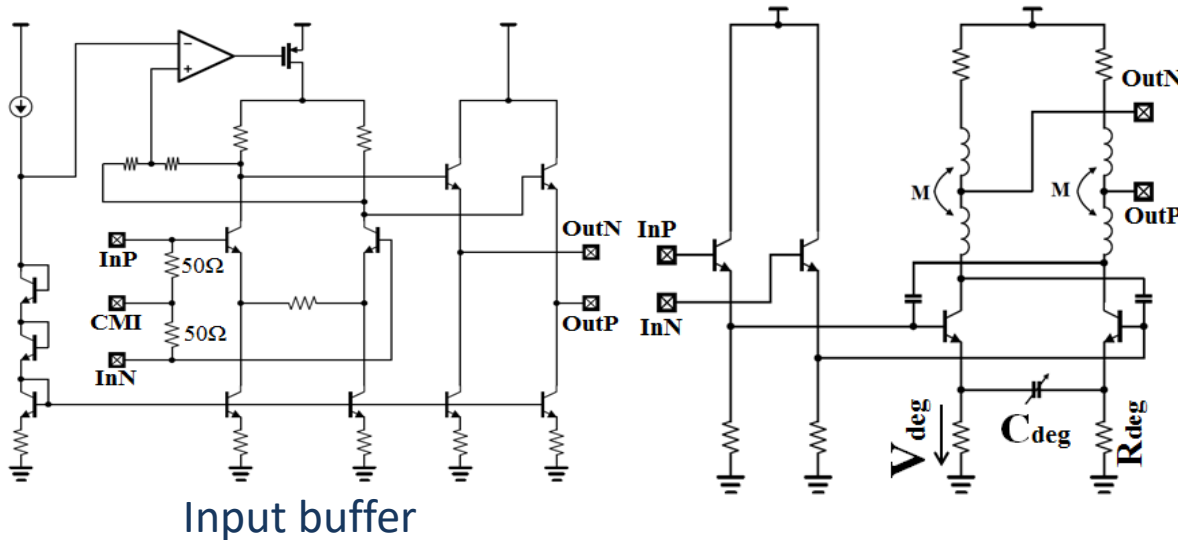
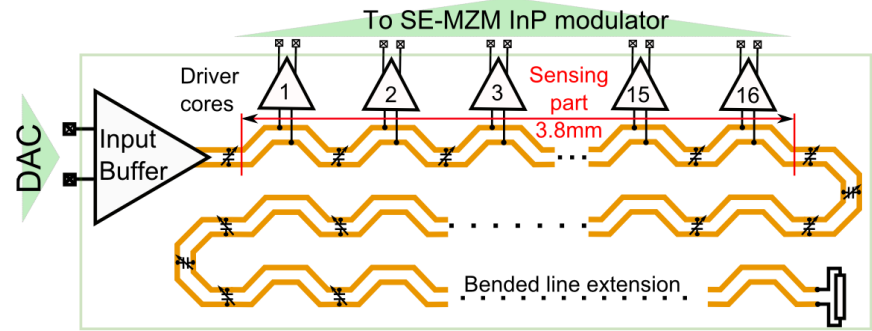
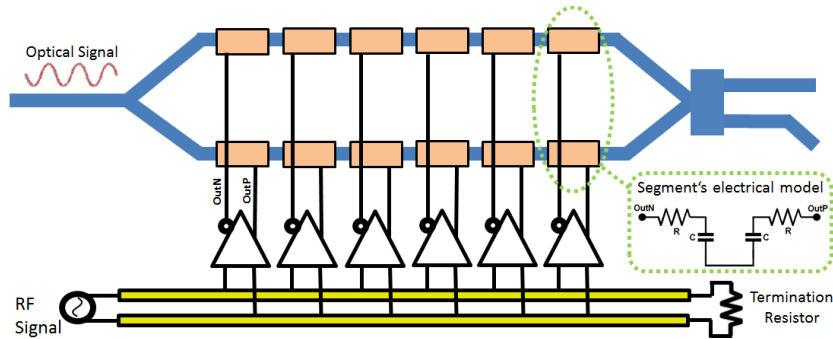


25 Gb/s Eye at Low and High Pre-emphasis Settings of the VCSEL Driver



Current Research Examples

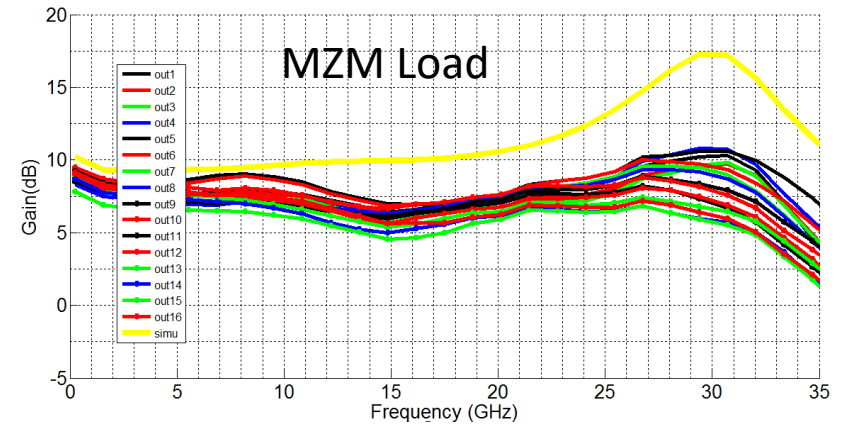
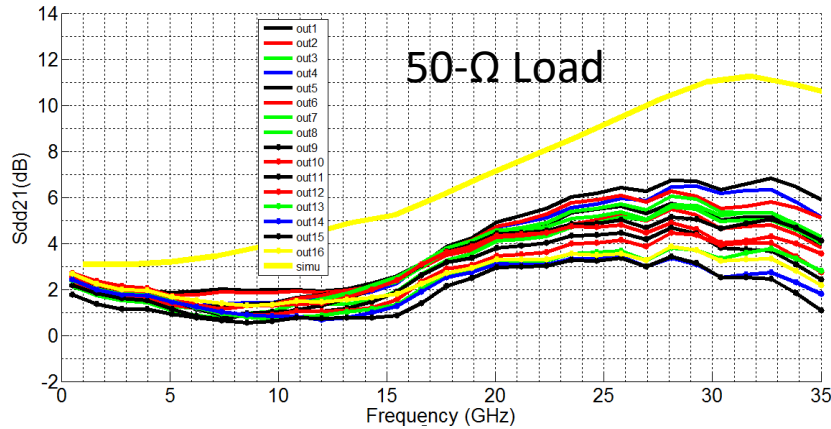
- MZM Driver**



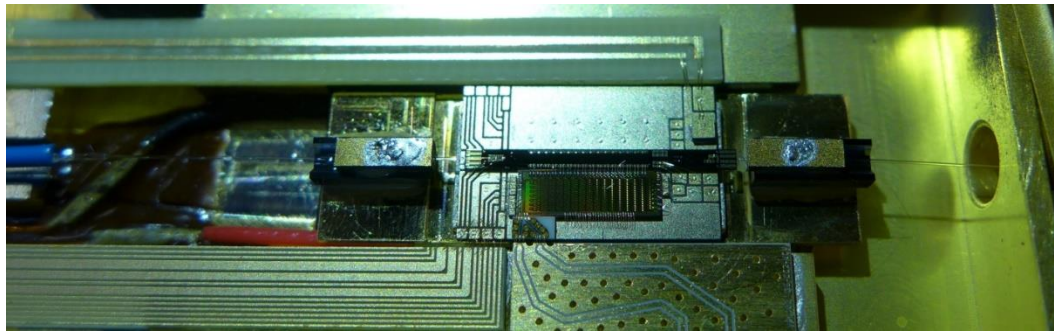
- 2.5 V V_{pp}
- BW 32 GHz
- PDC 1.6 W
- Tunable group delay for Optical/electrical matching

Current Research Examples

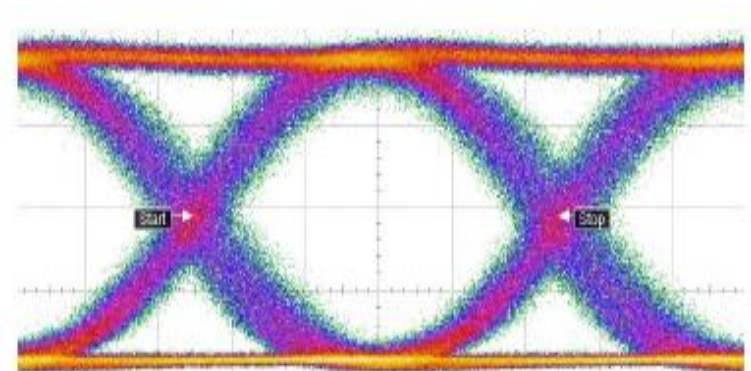
Gain measurement of each channel



Electrical large signal performance was verified as well



Segmented driver in electro/optical module

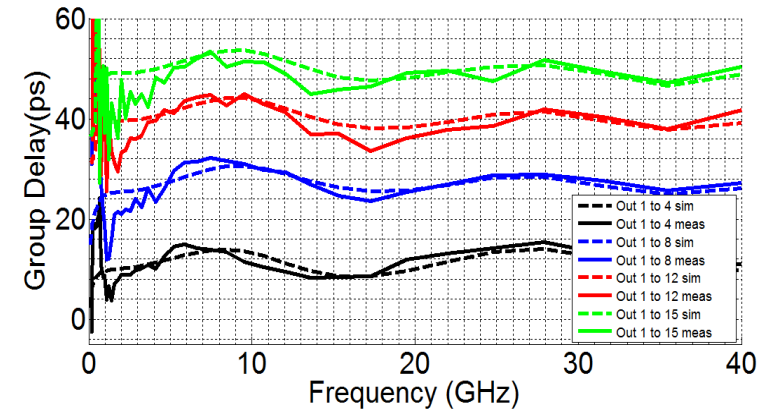
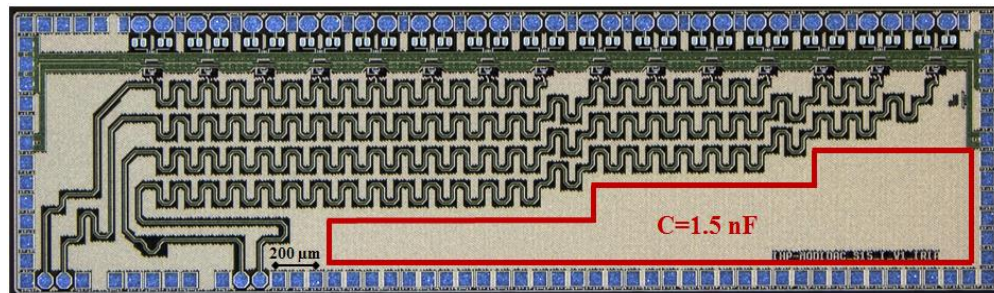
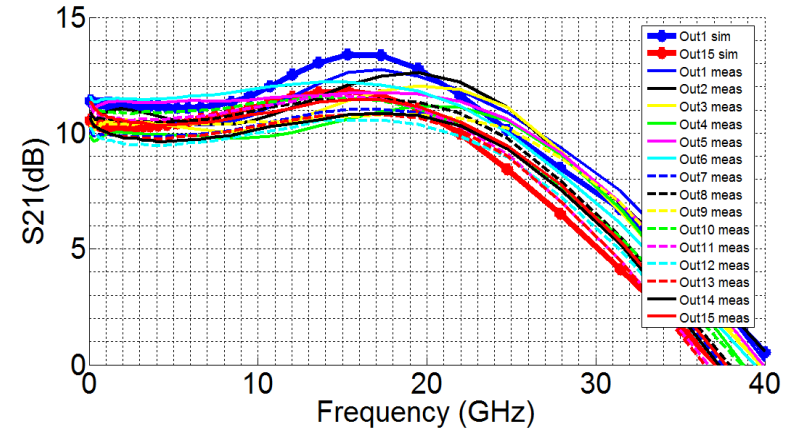
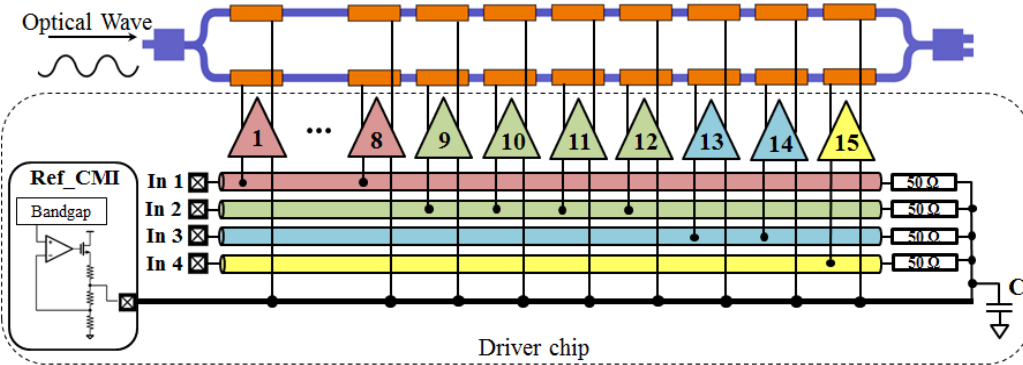


40 Gbps electro/optical eye diagram

I. G. López, A. C. Ulusoy *et al.*, "A 2.5 Vppd broadband 32 GHz BiCMOS linear driver with tunable delay line for InP segmented Mach-Zehnder modulators," *2015 IEEE MTT-S International Microwave Symposium*, Phoenix, AZ, 2015, pp. 1-4.

Current Research Examples

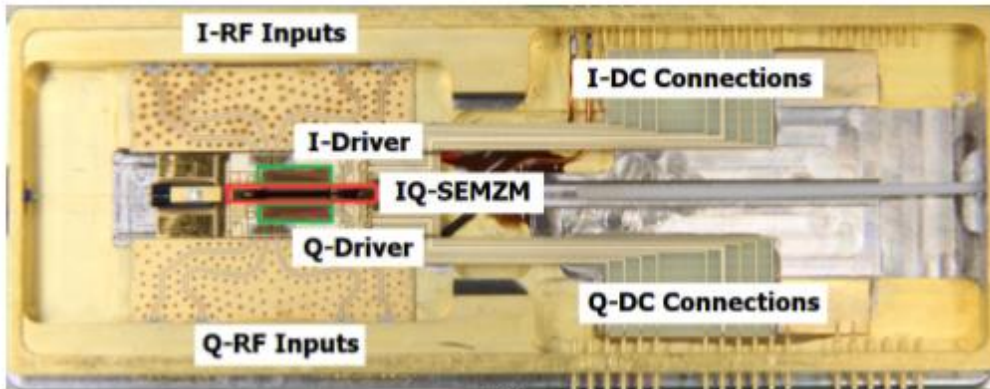
- Driver with 4-bit DAC



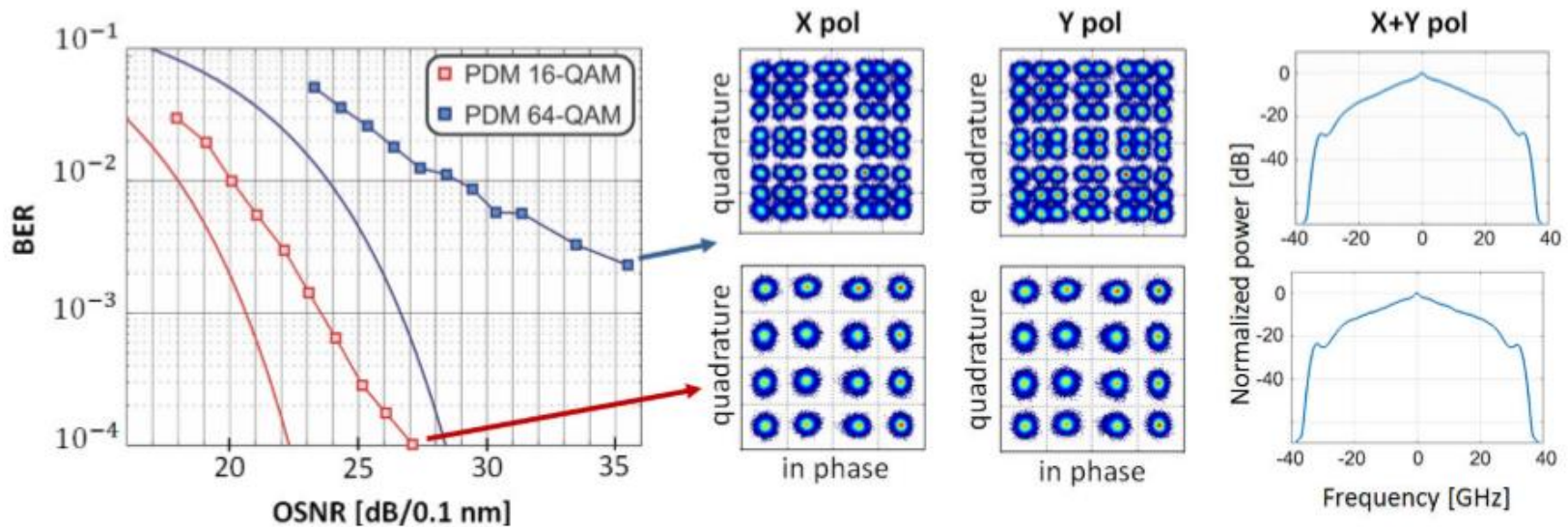
I. G. López, A. C. Ulusoy *et al.*, "A 40 Gbaud SiGe:C BiCMOS Driver for InP Segmented MZMs with Integrated DAC Functionality for PAM-16 Generation" IMS 2016

Current Research Examples

Segmented concept extended with 4-bit DAC functionality



Characterized in an electro/optical module
Presented at OFC as a post-deadline paper

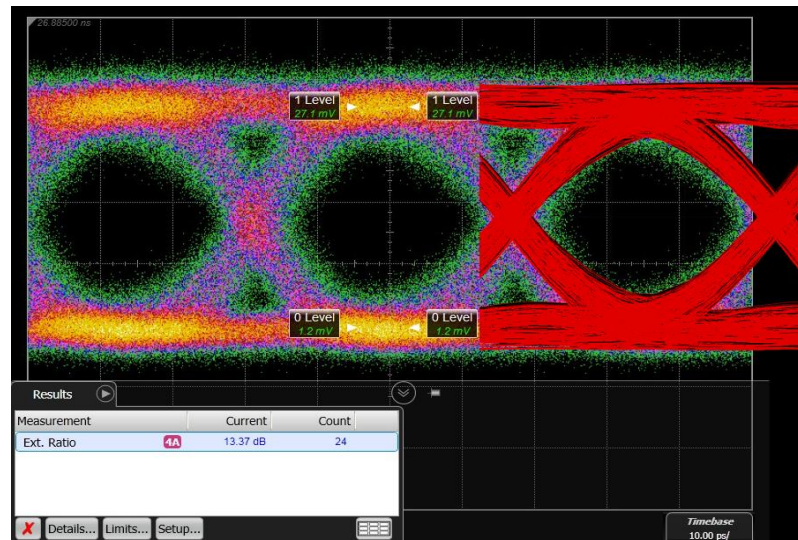
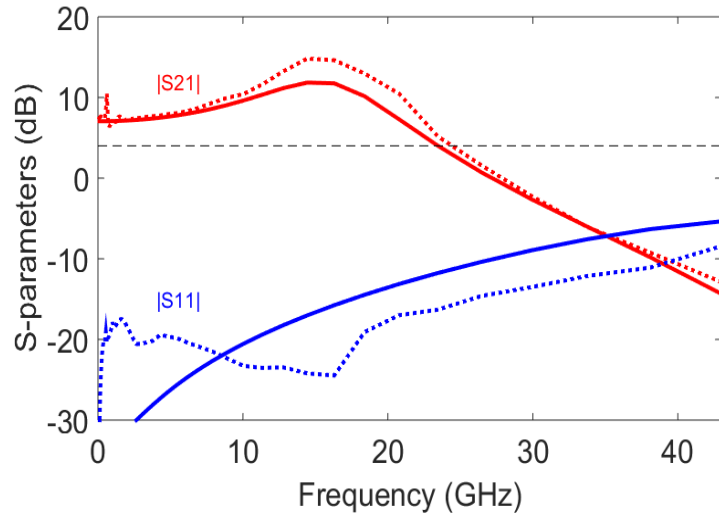
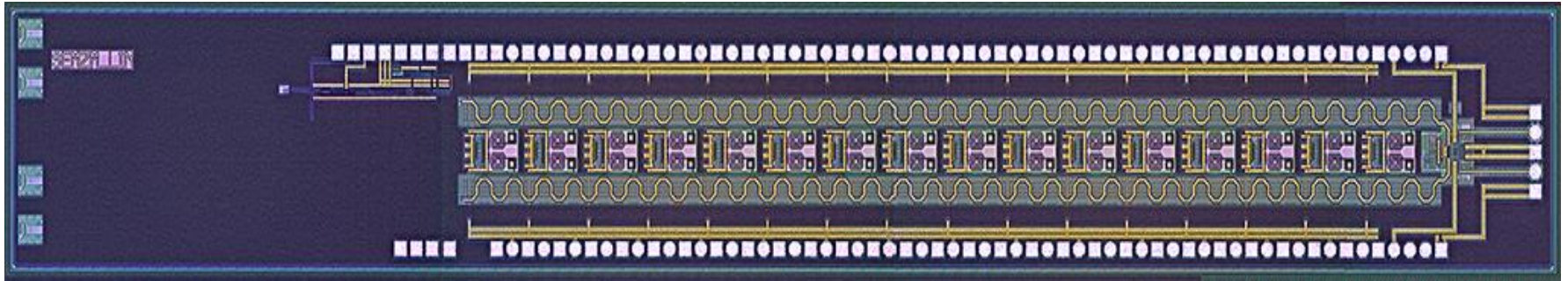


I. G. López, A. C. Ulusoy *et al.*, "DAC-free Ultra-Low-Power Dual-Polarization 64-QAM Transmission with InP IQ Segmented MZM Module " OFC 2016

Current Research Examples

- **EPIC Driver**

13 dB extinction ratio achieved at 28 Gb/s, 2-W power consumption, IC size 9.8x1.3 mm²



P. Rito, A. C. Ulusoy *et al.*, "A Monolithically Integrated Segmented Driver and Modulator in 0.25 μm SiGe:C BiCMOS with 13 dB Extinction Ratio at 28 Gb/s," IMS 2016

Lecture Plan

29. Apr		Introduction/Basics Communications	
06. Mai		Basics Communications/Photonic Components	Lab1
13. Mai		Photonic Components	
20. Mai		Transistors	Lab2
27. Mai		TIA Design	
03. Jun		TIA Design (Advanced Topics)	Lab3
10. Jun	Pfingstmontag		
17. Jun		Driver Design	Lab4
24. Jun		Driver Design (Advanced Topics)	
01. Jul		Bandwidth Enhancement Techniques	Lab5
08. Jul		DC Offset Compensation / Stability	
15. Jul		Gain Control and other advanced concepts (CLK data Recovery), Jitter	Lab6
22. Jul		Link imperfections, Optical Fibers, Equalizers	

Broadband Circuits for Wireless and Wireline Communications

- We went over main topics to be covered in BCWW and lecture structure
- Motivation and importance of Broadband Circuits for Wireless and Wireline Communications
- Recent research examples on this topic

4-channel version
of EPIC TIA
capable of 160 Gb/s

